

ROLE OF ARSENIC HEXAGONAL GROWTH-SUPPRESSION ON A CUBIC GaNAs GROWTH USING METALORGANIC CHEMICAL VAPOR DEPOSITION

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ABSTRACT

The hexagonal domain suppression-effects in cubic-GaNAs grown by metalorganic chemical-vapor deposition (MOCVD) is reported. A thin buffer layer (20 nm) was first grown on a substrate at 853 K using trimethylgallium and dimethylhydrazine (DMHy), and GaNAs samples were grown at different AsH₃ flow rates (0 ~ 450 μmol/min) at 1193 K. As a result, three types of surface morphologies were obtained: the first was a smooth surface (AsH₃ = 0 μmol/min); the second was a mirrorlike surface having small and isotropic grains (AsH₃ : 45 ~ 225 μmol/min); and the third involved three-dimensional surface morphologies (above 450 μmol/min of AsH₃ flow rate). Furthermore, it was confirmed using X-ray diffraction that the mixing ratio of hexagonal GaNAs in cubic GaNAs decreased with an increase of the AsH₃ flow rate. We could obtain GaNAs having a cubic component of above 85% at AsH₃ flow rates above 20 μmol/min. Therefore, the MOCVD growth method using AsH₃ and DMHy was mostly effective for suppressing hexagonal GaNAs. It was observed that the photoluminescence intensity of GaNAs was decreased with increase of arsine flow rate.

INTRODUCTION

III-N-V materials, such as GaNP and GaNAs, have a very large band-gap bowing and are very promising for light-emitting devices with a very wide wavelength region from ultraviolet to infrared [1,2]. They are expected to realize a wider range of bandgaps with a smaller lattice mismatch to GaN.

However, III-N-V type alloys can be hardly grown under an equilibrium condition, since they have a very large miscibility gap [3,4]. The gas-source molecular-beam epitaxy (GSMBE) growth of nitrogen (N) rich hexagonal (h) GaNAs [5] and GaNP [6,7] alloys on sapphire substrates and their optical properties have been recently reported. The maximum As and P concentrations of these alloys with a hexagonal structure are so far limited to 0.26% [6] and 8.3% [7], respectively. However, there has been no report on a metalorganic chemical vapor deposition (MOCVD) growth of cubic-GaNAs using

the dimethylhydrazine (DMHy). In this paper, the As effect for hexagonal growth-suppression on cubic GaNAs growth is reported in MOCVD.

EXPERIMENTAL

GaNAs was grown on a GaAs (001) substrate using a horizontal MOCVD apparatus. The pressure in the reactor was 160 Torr. Trimethylgallium (TMG), DMHy [(CH₃)₂NNH₂] and arsine (AsH₃) were used as precursors of Ga, N, and As, respectively. A GaN buffer layer of about 20 nm in thickness was grown on the substrate using TMG and DMHy at 853 K. After that, a GaNAs layer was grown on the GaN buffer layer at 1193 K under the conditions of different AsH₃ flows. The growth temperature was constant at 1193 K, since when the growth temperatures were lower than 1193 K and also higher than 1223 K, the grown surface became rough. The surface morphologies of the samples were observed by scanning electron microscopy (SEM), and the surface roughness was measured by atomic force microscopy (AFM). The crystal structure was investigated by an X-ray diffraction (XRD) measurement. Secondary ion mass spectrometry (SIMS) was carried out to estimate As incorporation into the c-GaN films. To investigate the optical properties, a photoluminescence measurement of GaNAs was carried out using a He-Cd laser (325 nm) at 5K.

RESULTS AND DISCUSSION

In order to increase the As incorporation into cubic GaNAs, the AsH₃ flow rate was changed from 0 to 450 μmol/min and the flow rates of TMG and DMHy were fixed at 18 and 230 μmol/min, respectively. Without AsH₃ flow, the growth rate of c-GaN was 1.5 nm/sec. When the AsH₃ flow was increased to 450 μmol/min, the growth rate was reduced to 1.0 nm/sec. The thickness of the epitaxial layers was approximately 600 nm. Figure 1 shows the surface morphologies of the samples at different AsH₃ flow rates ranging from 0 to 450 μmol/min, observed by SEM. Figure 1 (a) shows GaN surface morphologies without AsH₃ flow. The shape of the grains is elongated in the [110] direction and the length of each grain is several microns. These grains have a tendency to form (111) B facets and (113) A facets [8]. Figure 1 (b) shows the surface morphologies in the case of AsH₃ flow under 225 μmol/min. The surface was smooth and the grains were smaller with more isotropic shapes. When the AsH₃ flow rate was, moreover, as large as 450 μmol/min, the GaNAs growth was more three dimensional and the grains were also isotropic and larger.

We also observed the AFM images in order to investigate the surface roughness of GaNAs layers grown at different AsH₃ flow rates (0 ~ 225 μmol/min). It was found that the surface became smoother with increasing the AsH₃ flow rate. That is, the root-mean-square (rms) showing a surface roughness became smaller than 22.7 nm with increasing the AsH₃ flow rate. The above-mentioned results of SEM and AFM indicate that with AsH₃ the grain size and shape was smaller and more isotropic, and that the surface was smoother, although the growth rate decreased with increasing AsH₃ flow.

This is considered to be due to As adsorption on the GaN surface during the growth process. It is considered that As adsorption on the GaN surface lowers the surface energy to stabilize the (001) surface, resulting in suppressing the generation of a hexagonal structure, as Foxon et al previously reported [9].

Figure 2 shows three-dimensional maps of XRD of the two grown layers with and without AsH₃ flow. The X-ray incident azimuth was the {1-10} direction. Two different diffraction peaks from h-GaN (1-101) were observed along with the main diffraction from c-GaN (002), as shown in Figure 2 (a). With this X-ray incident azimuth, the h-GaN (1-101) domains, holding on two different (111) B surfaces, were observed. The

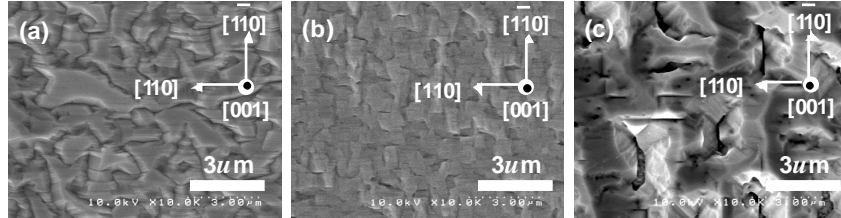


Figure 1. SEM images of samples with various AsH₃ flow rates ranging from 0 to 450 μmol/min. (a) AsH₃=0 μmol/min, ϕ =AsH₃/(AsH₃+DMHy)=0, (b) AsH₃=225 μmol/min, ϕ =0.49, (c) AsH₃=450 μmol/min, ϕ =0.66.

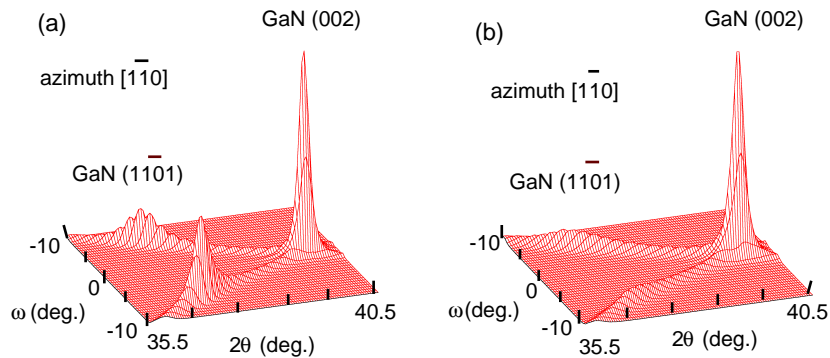


Figure 2. Three-dimensional graphs of reciprocal space maps of (a) c-GaN and (b) c-GaNAs (AsH₃ flow rate was 90 μmol/min) with X-ray beams incident along the <1010> azimuth.

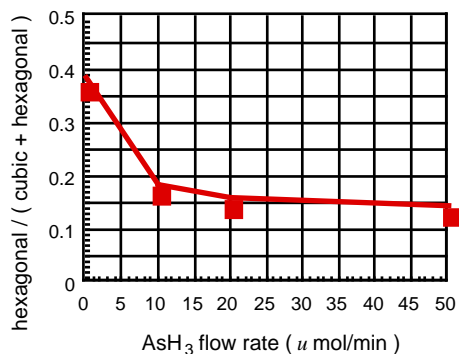


Figure 3. Concentration of the hexagonal phase in the c-GaN layers with various AsH₃ flow rates.

diffraction-peak intensity from h-GaN (1-101) on (111) B surfaces was much larger than from h-GaN on (111) A surfaces; this is consistent with that the grains at the c-GaN surface have (111) B facets and do not have (111) A facets. Interestingly, with AsH₃ flow, the diffraction intensity from h-GaN (1-101) becomes significantly weaker. This tendency was common to these samples with AsH₃ flow under 225 μmol/min. We estimated the concentration of the hexagonal phase in the c-GaN layers by comparing with the integrated diffraction intensities of c-GaN (002) and h-GaN (1-101) [10]. It is considered that with AsH₃ flow during the c-GaN growth, As adsorbs on the GaN (001) surface and prevents the generation of (111) facets, resulting in maintaining the surface flatness. This smooth surface is favorable to c-GaN growth, because h-GaN is easy to grow with its c-axis parallel to the <111> directions. Figure 3 shows the concentration of the hexagonal phase in epilayers at different AsH₃ flow rates. It was confirmed that with increasing the AsH₃ flow the concentration of the hexagonal phase significantly decreased to 15%. That is, this growth condition is very effective for suppressing of hexagonal GaNAs.

Figure 4 shows SIMS depth profiles of the samples with AsH₃ flow of 0 and 225 μmol/min. The As intensity of the samples with an AsH₃ flow rate of 225 μmol/min became larger, as large as 20 in the same scale. The As counts increased according to the increase in the AsH₃ flow rate up to 225 μmol/min. Therefore, As was actually incorporated in the c-GaN layers by the AsH₃ flow. When the AsH₃ flow rate was 450 μmol/min, GaNAs polycrystals were observed in the GaNAs layer. In order to further incorporate the As into GaNAs, the growth condition must to be further improved.

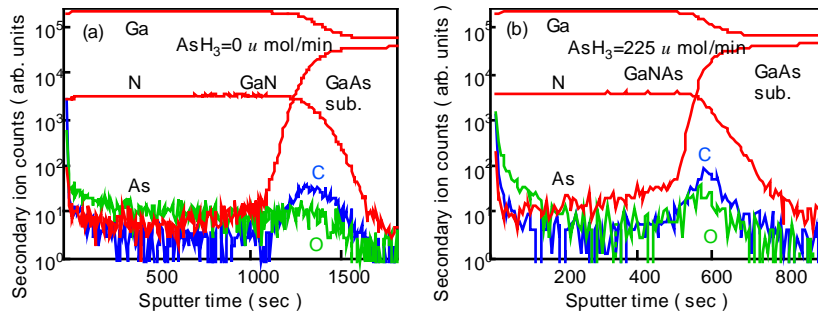


Figure 4. SIMS depth profiles of (a) c-GaN (without AsH₃ flow), (b) c-GaNAs (AsH₃ flow rate was 225 μmol/min).

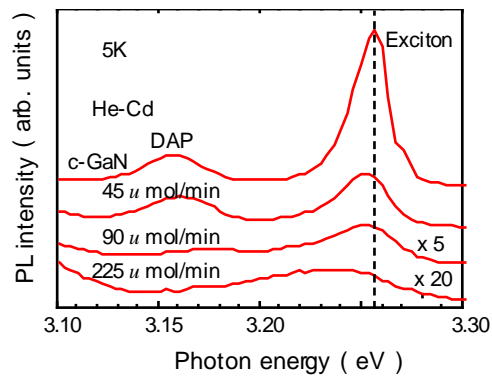


Figure 5. PL spectra of near-band edges with various AsH₃ flow rates at 5k.

We next carried out a photoluminescence (PL) measurement of GaNAs grown at different AsH₃ flow rates to investigate the optical properties. The two main peaks were observed. That is, the excitonic emission at 3.256 eV and the donor-acceptor pair recombination at 3.156 eV were observed in the PL spectrum of c-GaN. With increasing the AsH₃ flow rate, the excitonic emission became weak and the deep luminescence band around 2.8 eV became dominant. Figure 5 shows the near-band-edge emission of the GaNAs PL spectra. With increasing the AsH₃ flow rate, the exciton peak shifts toward lower energies and becomes broad. This is due to As incorporation in the c-GaN layer. The maximum value of the peak shift is 20 meV, which corresponds to approximately 0.1% As concentration, as estimated from the bowing parameter of h-GaNAs (19.6 eV) [5].

CONCLUSION

The hexagonal domain suppression-effects in c-GaNAs grown by MOCVD using DMHy were investigated. GaNAs samples were grown at different AsH₃ flow rates (0 ~ 450 μmol/min) at 1193 K. As a result, three types of surface morphologies were obtained: the first was obtained as a smooth surface (AsH₃ = 0 μmol/min); the second was a smooth surface having small and isotropic grains (AsH₃ : 45 ~ 225 μmol/min); and the third involved three-dimensional surface morphologies (above 450 μmol/min of AsH₃ flow rate). Furthermore, it was confirmed using X-ray diffraction that the mixing ratio of hexagonal GaNAs in cubic GaNAs decreased along with an increase in the AsH₃ flow rate. We could obtain GaNAs having a cubic component above 85% at AsH₃ flow rates above 20 μmol/min. Therefore, the MOCVD growth method using AsH₃ and DMHy was effective for suppressing hexagonal GaNAs.

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